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Vishay Siliconix

N-Channel 20 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}$ (Ω) MAX.	I _D (A) ^d	Q _g (TYP.)			
	0.030 at $V_{GS} = 4.5 \text{ V}$	5.9				
20	0.034 at V _{GS} = 2.5 V	5.5	7.7 nC			
	0.041 at V _{GS} = 1.8 V	5				

FEATURES

- TrenchFET® power MOSFET
- 100 % R_g tested
- Material categorization:
 For definitions of compliance please see www.vishay.com/doc?99912



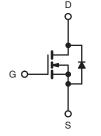
ROHS COMPLIANT HALOGEN FREE





APPLICATIONS

- · Load switch
- Power management



N-Channel MOSFET

Marking Code: F5
Ordering Information:

Si2374DS-T1-GE3 (Lead (Pb)-free and Halogen-free)

PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	20	
Gate-Source Voltage		V _{GS}	± 8	V
	T _C = 25 °C		5.9	
Continuous Drain Current /T 150 °C)	T _C = 70 °C	1 , [4.7	
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	I _D	4.5 ^{a, b}	
	T _A = 70 °C		3.6 ^{a, b}	Α
Pulsed Drain Current (t = 100 μs)		I _{DM}	25	
Continuous Courses Brain Binds Coursest	T _C = 25 °C	,	1.4	
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	0.8 ^{a, b}	
	T _C = 25 °C		1.7	
Martin on Brown Black of the	T _C = 70 °C		1.1	347
Maximum Power Dissipation	T _A = 25 °C	P _D	0.96 ^{a, b}	W
	T _A = 70 °C	1	0.62 ^{a, b}	
Operating Junction and Storage Temperature Range		T _J , T _{stq}	-55 to 150	°C

THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	TYPICAL	MAXIMUM	UNIT			
Maximum Junction-to-Ambient a, c	t ≤ 5 s	R_{thJA}	100	130	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	60	75	C/VV		

Notes

- a. Surface mounted on 1" x 1" FR4 board.
- b. t = 5 s.
- c. Maximum under steady state conditions is 175 °C/W.
- d. $T_C = 25$ °C.



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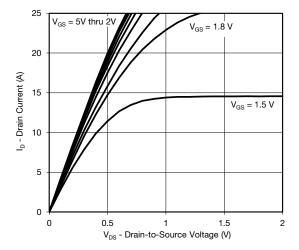
SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static				•		•	
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	20	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L 050 ·· A	-	34	-	mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-5	-		
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	0.4	-	1	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$	-	-	± 100	nA	
Zava Cata Valtaga Dvain Current		V _{DS} = 20 V, V _{GS} = 0 V			1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 20 V, V _{GS} = 0 V, T _J = 55 °C	-	-	10	μA	
On-State Drain Current ^a	I _{D(on)}	V _{DS} ≥ 5 V, V _{GS} = 10 V	10	-	-	Α	
		V _{GS} = 4.5 V, I _D = 4 A	-	0.025	0.030		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 2.5 V, I _D = 3 A	-	0.028	0.034		
		V _{GS} = 1.8 V, I _D = 2 A	-	0.031	0.041		
Forward Transconductance ^a	g_{fs} $V_{DS} = 10 \text{ V}, I_D = 4 \text{ A}$		-	29	-	S	
Dynamic ^b				•		•	
Input Capacitance	C _{iss}		-	735	-	pF	
Output Capacitance	Coss	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	-	110	-		
Reverse Transfer Capacitance	C _{rss}		-	40	-		
T		$V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 4.5 \text{ A}$	-	13.4	20	nC	
Total Gate Charge	Qg		-	7.7	12		
Gate-Source Charge	Q _{gs}	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 4.5 \text{ A}$	-	1	-		
Gate-Drain Charge	Q _{gd}		-	1	-		
Gate Resistance	Rg	f = 1 MHz	0.12	0.6	1.2	Ω	
Turn-On Delay Time	t _{d(on)}		-	4	8		
Rise Time	t _r	$V_{DD} = 10 \text{ V}, R_L = 2.8 \Omega$	-	22	33		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 3.6 \text{ A}, V_{GEN} = 8 \text{ V}, R_g = 1 \Omega$	-	16	24		
Fall Time	t _f		-	9	18	1	
Turn-On Delay Time	t _{d(on)}		-	10	20	ns	
Rise Time	t _r	$V_{DD} = 10 \text{ V}, R_L = 2.8 \Omega$	-	23	35		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 3.6 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$	-	16	24		
Fall Time	t _f		-	10	20		
Drain-Source Body Diode Characteristics							
Continuous Source-Drain Diode Current	Is	T _C = 25 °C		-	1.4		
Pulse Diode Forward Current (t = 100 μs)	I _{SM}		-	-	25	Α	
Body Diode Voltage	V _{SD}	I _S = 3.6 A, V _{GS} = 0 V	-	0.8	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}		-	13	20	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	1 0 0 A 41/44 400 A / 5 T 05 20	-	6	12	nC	
Reverse Recovery Fall Time	ta	$I_F = 3.6 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$	-	9	-		
Reverse Recovery Rise Time	t _b		-	4	-	ns	

Notes

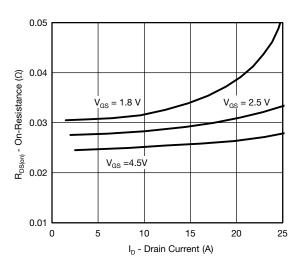
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

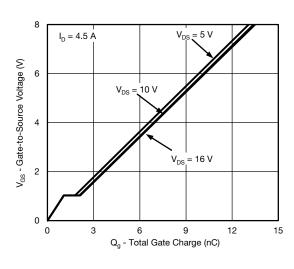




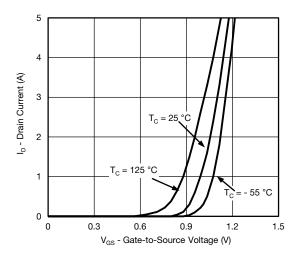
Output Characteristics



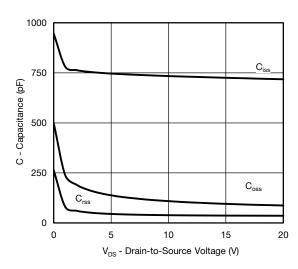
On-Resistance vs. Drain Current and Gate Voltage



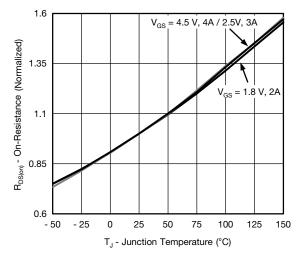
Gate Charge



Transfer Characteristics

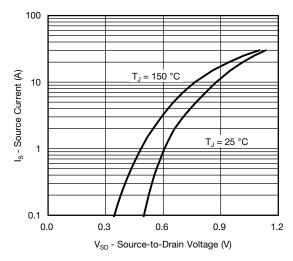


Capacitance

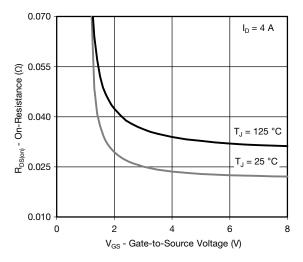


On-Resistance vs. Junction Temperature

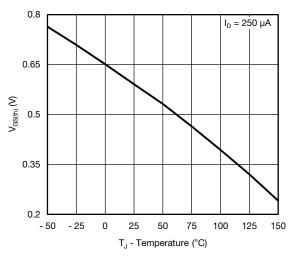




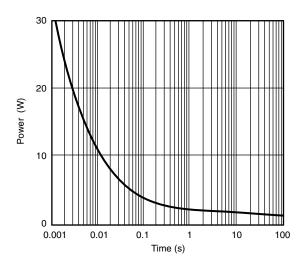




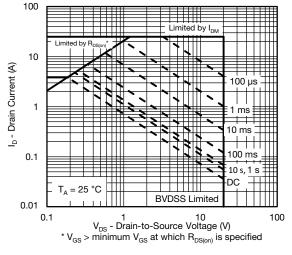
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage

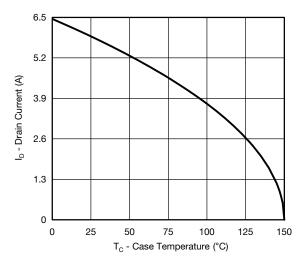


Single Pulse Power (Junction-to-Ambient)



Safe Operating Area, Junction-to-Ambient

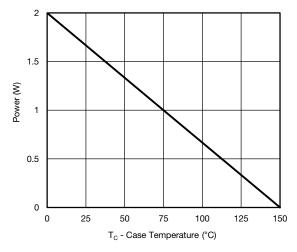


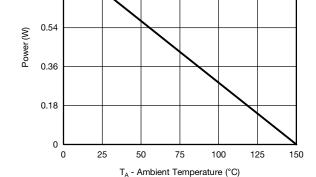


Current Derating*

0.9

0.72



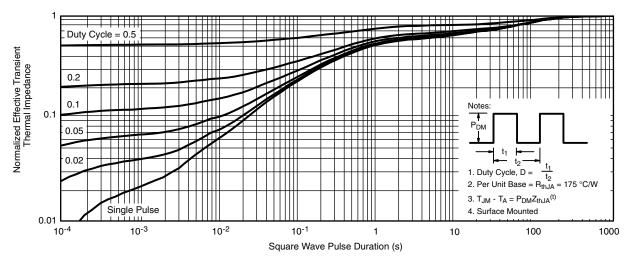


Power Junction-to-Foot

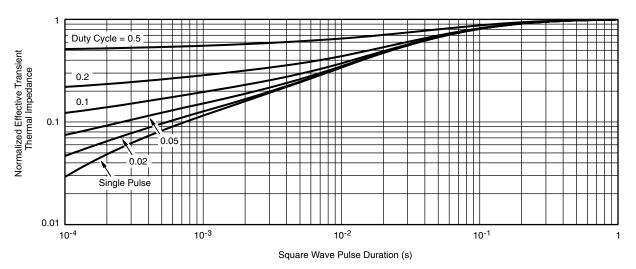
Power Junction-to-Ambient

^{*} The power dissipation P_D is based on $T_{J (max.)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient

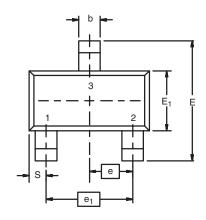


Normalized Thermal Transient Impedance, Junction-to-Foot

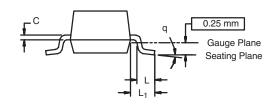
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SOT-23 (TO-236): 3-LEAD







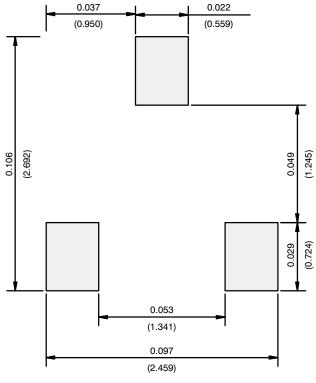
Dim -	MILLIN	IETERS	INCHES		
	Min	Max	Min	Max	
Α	0.89	1.12	0.035	0.044	
A ₁	0.01	0.10	0.0004	0.004	
A ₂	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
С	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E ₁	1.20	1.40	0.047	0.055	
е	0.95	BSC	C 0.037-		
e ₁	1.90	BSC	0.074	8 Ref	
L	0.40	0.60	0.016	0.024	
L ₁	0.64 Ref		0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	
ECN: S-03946-Rev. K. 09-	Jul-01				

DWG: 5479

Document Number: 71196 www.vishay.com 09-Jul-01



RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE

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